ATTACHMENT A

New Claims

Following herewith is a clean copy of each new claim.

11. A chamber cleaning gas comprising at least one gas selected from the

group consisting of 0 and CF₃. 5929963

12. A chamber cleaning gas according to claim 11 comprising

hexafluoropropylene oxide represented by the formula

CF₃CF-CF₂

disclosed in

4,581,101

col 4 line 60

- 13. A chamber cleaning gas according to claim 11 comprising CF₃COCF₃.
- 14. A chamber cleaning gas according to claim 11 which further comprises at least one monomer gas selected from the group consisting of He, Ne, Ar, H₂, N₂ and O₂.
- 15. A chamber cleaning method comprising the step of treating a plasma CVD chamber of a semiconductor integrated circuit production device with at least one

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- 16. A chamber cleaning method according to claim 15 wherein the chamber cleaning gas is hexafluoropropylene oxide represented by the formula $^{\rm CF_3CF-CF_2}$
- 17. A chamber cleaning method according to claim 15 wherein the chamber cleaning gas is CF₃COCF₃.
- 18. A chamber cleaning method according to claim 15 which further comprises at least one monomer gas selected from the group consisting of He, Ne, Ar, H_2 , N_2 and O_2 .